

Page 1 of 2 APPLICATION NO. 10/779,823 ATTY. DOCKET NO. 1857.2610000 FIRST NAMED INVENTOR

INFORMATION DISCLOSURE STATEMENT

Cheng-Qun GUI
FILING DATE
February 18, 2004

ART UNIT 2851

				ENT DOCUMENTS	[205]		
XAMINER NITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB-CLASS	FILING DATE
D.R.	AA1	5,500,736	03/1996	Koitabashi et al.	356	401	
	AB1	5,523,193	06/1996	Nelson	4 30	311	
	AC1	5,530,482	06/1996	Gove et al.	348		
	AD1	5,579,147	11/1996	Mori et al.		204	
	AE1	5,677,703	10/1997	Bhuva et al.	345		
	AF1	5,808,797	09/1998	Bloom et al.		572	
	AG1	5,982,553	11/1999	Bloom et al.	359		
	AH1	6,133,986	10/2000	Johnson	355		
	Al1	6,177,980 B1	01/2001	Johnson	355		
7) 2	AJ1	6,687,041 B1	02/2004	Sandstrom	359	291	
\mathcal{D}, \mathcal{C}				ATENT DOCUMENTS	1-32_7	27	l
XAMINER NITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLATIO
	AK1	EP 1 482 375 A2	12/2004	EP			N
	AL						Y
	AM						Y
		OTHER (Include	ding Author	, Title, Date, Pertinent	Pages, etc.)	<u>l</u>	· ·
	AN					/	
	AO						
	AP				211-2-17		
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Page 2 of 2 TE TRATES ATTY. DOCKET NO. APPLICATION NO. 1857.2610000 10/779,823 **FORM PTO-1449** FIRST NAMED INVENTOR Cheng-Qun GUI INFORMATION DISCLOSURE STATEMENT ART UNIT FILING DATE February 18, 2004 2851 **U.S. PATENT DOCUMENTS** EXAMINER DOCUMENT NUMBER INITIAL DATE NAME CLASS SUB-CLASS **FILING DATE** 06/2004 AA2 6,747,783 B1 Sandstrom AB2 6,795,169 B2 09/2004 Tanaka et al. 6,806,897 B2 10/2004 Kataoka et al. AC2 11/2004 AD2 6,811,953 B2 Hatada et al. AE2 2004/0041104 A1 03/2004 Liebregts et al. AF2 2004/0130561 A1 07/2004 Jain AG AH ΑI **FOREIGN PATENT DOCUMENTS** EXAMINER INITIAL TRANSLATION **DOCUMENT NUMBER** DATE COUNTRY CLASS SUB-CLASS Yes ΑK No Yes AL No Yes **AM** No OTHER (Including Author, Title, Date, Pertinent Pages, etc.) AN AO AP AQ AR

EXAMINED: DATE CONSIDERED

3 22 2005

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.